International TOR Rectifier

HFA30PA60C

HEXERED™

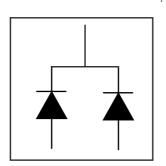
Ultrafast, Soft Recovery Diode

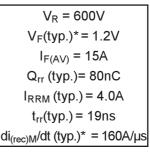
Features

- · Ultrafast Recovery
- · Ultrasoft Recovery
- Very Low I_{RRM}
- Very Low Q_{rr}
- · Guaranteed Avalanche
- · Specified at Operating Conditions

Benefits

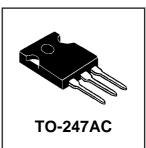
- · Reduced RFI and EMI
- Reduced Power Loss in Diode and Switching Transistor
- · Higher Frequency Operation
- · Reduced Snubbing
- · Reduced Parts Count





Description

International Rectifier's HFA30PA60C is a state of the art center tap ultra fast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600 volts and 15 amps per Leg continuous current, the HFA30PA60C is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultra fast recovery time, the HEXFRED product line features extremely low values of peak recovery current (I_{RRM}) and does not exhibit any tendency to "snap-off" during the $t_{\rm b}$ portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED HFA30PA60C is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.



Absolute Maximum Ratings (per Leg)

	Parameter	Max.	Units	
V _R	Cathode-to-Anode Voltage	600	V	
I _F @ T _C = 25°C	Continuous Forward Current			
I _F @ T _C = 100°C	Continuous Forward Current	15		
I _{FSM}	Single Pulse Forward Current	150	A	
I _{FRM}	Maximum Repetitive Forward Current	60		
I _{AR} ①	Maximum Repetitive Avalanche Current	2.0		
P _D @ T _C = 25°C	Maximum Power Dissipation	74	w	
P _D @ T _C = 100°C	Maximum Power Dissipation	29	VV	
T _J	Operating Junction and	55 to 1450	С	
T _{STG}	Storage Temperature Range	-55 to +150		

^{* 125°}C

Electrical Characteristics (per Leg) @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
V_{BR}	Cathode Anode Breakdown Voltage	600			V	I _R = 100μA	
V _{FM}	Max Forward Voltage		1.3	1.7	V	I _F = 15A	
			1.5	2.0		I _F = 30A See Fig. 1	
			1.2	1.6		I _F = 15A, T _J = 125°C	
I _{RM}	Max Reverse Leakage Current		1.0	10	μΑ	$V_R = V_R$ Rated See Fig. 2	
			400	1000		$T_J = 125$ °C, $V_R = 0.8 \times V_R$ Rated	
C _T	Junction Capacitance		25	50	pF	V _R = 200V See Fig. 3	
L _S	Series Inductance		12		· nH	Measured lead to lead 5mm from	
						package body	

Dynamic Recovery Characteristics (per Leg)@ T_J = 25°C (unless otherwise specified)

	,			,			
	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
t _{rr}	Reverse Recovery Time		19			$I_F = 1.0A$, $di_f/dt = 200A/\mu s$, $V_R = 30$	
t _{rr1}	See Fig. 5, 10		42	60	ns	T _J = 25°C	
t _{rr2}			70	120		T _J = 125°C	I _F = 15A
I _{RRM1}	Peak Recovery Current		4.0	6.0	Α	T _J = 25°C	
I _{RRM2}	See Fig. 6		6.5	10	^	T _J = 125°C	$V_{R} = 200V$
Q _{rr1}	Reverse Recovery Charge		80	180	nC	T _J = 25°C	
Q _{rr2}	See Fig. 7		220	600	110	T _J = 125°C	$di_f/dt = 200A/\mu s$
di _{(rec)M} /dt1	Peak Rate of Fall of Recovery Current		250		A/us	T _J = 25°C	
di _{(rec)M} /dt2	During t _b See Fig. 8		160		ΑνμS	$T_J = 125$ °C	

Thermal - Mechanical Characteristics (per Leg)

	Parameter	Min.	Тур.	Max.	Units		
T _{lead} ②	Lead Temperature			300	°C		
R _θ JC	Junction-to-Case, Single Leg Conducting			1.7	K/W		
	Junction-to-Case, Both Legs Conducting			0.85			
R _{0JA} 3	Thermal Resistance, Junction to Ambient			40			
R _{0CS}	Thermal Resistance, Case to Heat Sink		0.25		1		
VVt	Weight		6.0		g		
	VVCignt		0.21		(oz)		
	Mounting Torque	6.0		12	Kg-cm		
	mounting relique	5.0		10	lbf•in		

- \odot L=100 μ H, duty cycle limited by max T_J
- ② 0.063 in. from Case (1.6mm) for 10 sec
- 3 Typical Socket Mount
- Mounting Surface, Flat, Smooth and Greased

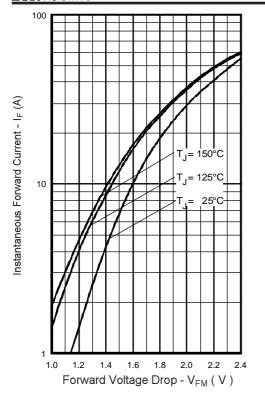


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current, (per Leg)

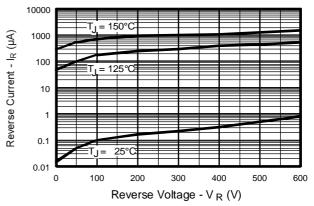


Fig. 2 - Typical Reverse Current vs. Reverse Voltage, (per Leg)

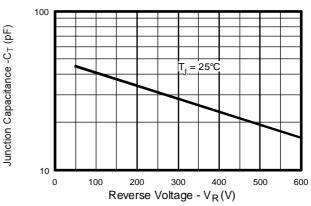


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage, (per Leg)

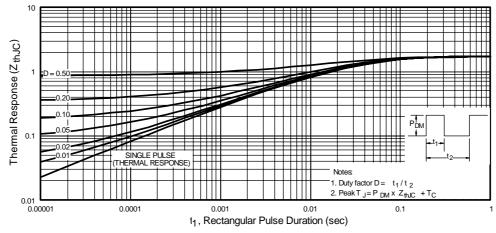


Fig. 4 - Maximum Thermal Impedance Z_{thjc} Characteristics, (per Leg)

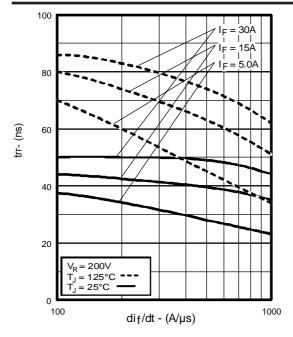


Fig. 5 - Typical Reverse Recovery Time vs. di_f/dt, (per Leg)

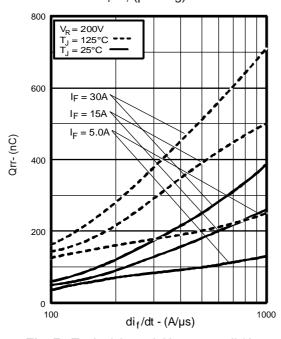


Fig. 7 - Typical Stored Charge vs. di_f/dt, (per Leg)

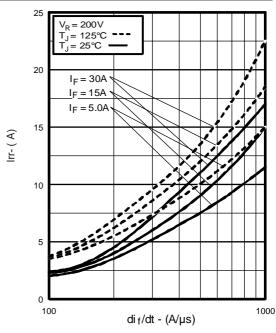


Fig. 6 - Typical Recovery Current vs. di_f/dt, (per Leg)

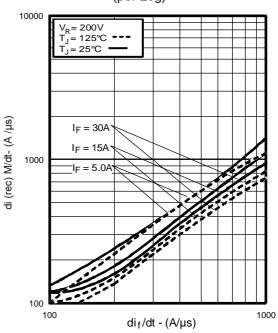


Fig. 8 - Typical di_{(rec)M}/dt vs. di_f/dt, (per Leg)

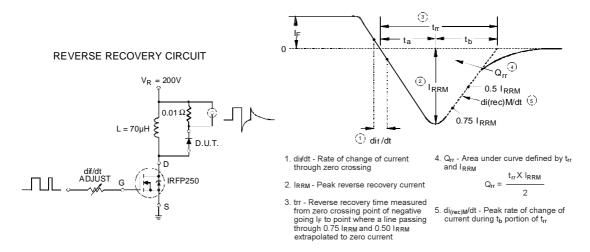


Fig. 9 - Reverse Recovery Parameter Test Circuit

Fig. 10 - Reverse Recovery Waveform and Definitions

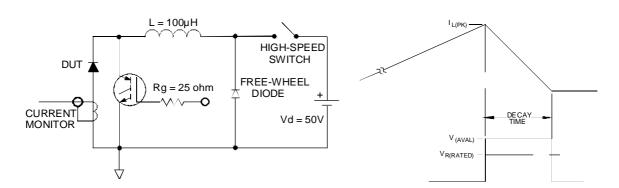
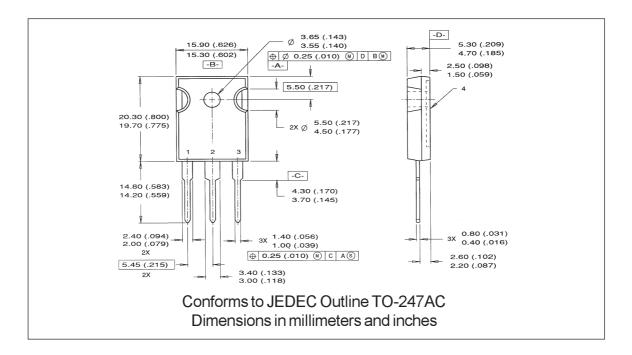


Fig. 11 - Avalanche Test Circuit and Waveforms



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